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Author(s): Jalkanen, J. & Rossi, G. & Trushin, O. & Granato, E. & Ala-Nissilä, Tapio & Ying, S.-C.

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Stress release mechanisms for Cu on Pd(111) in the submonolayer and monolayer regimes

J. Jalkanen,¹ G. Rossi,¹ O. Trushin,² E. Granato,^{3,4} T. Ala-Nissila,^{1,4} and S.-C. Ying⁴

¹*Department of Applied Physics and COMP Center of Excellence, Helsinki University of Technology, FI-02015 TKK, Espoo, Finland*

²*Institute of Physics and Technology, Yaroslavl Branch, Academy of Sciences of Russia, Yaroslavl 150007, Russia*

³*Laboratório Associado de Sensores e Materiais, Instituto Nacional de Pesquisas Espaciais, 12201-970 São José dos Campos, SP, Brazil*

⁴*Department of Physics, P.O. Box 1843, Brown University, Providence, Rhode Island 02912-1843, USA*

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We study the strain relaxation mechanisms of Cu on Pd(111) up to the monolayer regime using two different computational methodologies, basin-hopping global optimization and energy minimization with a repulsive bias potential. Our numerical results are consistent with experimentally observed layer-by-layer growth mode. However, we find that the structure of the Cu layer is not fully pseudomorphic even at low coverages. Instead, the Cu adsorbates forms fcc and hcp stacking domains, separated by partial misfit dislocations. We also estimate the minimum energy path and energy barriers for transitions from the ideal epitaxial state to the fcc-hcp domain pattern.

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Introduction. Metallic surfaces and nanostructures are essential systems for heterogeneous catalysis. Combination of two metals can lead to significant improvements in the variability and frequency of the reactions catalyzed. To prepare controlled nanostructures, it is crucial to understand the growth and stability of heteroepitaxial metal systems, in particular for close-packed surfaces. On fcc(111) it has been found that to release the stress, the overlayer can adopt several alternative strategies which lead to a structure of domains separated by partial misfit dislocations.¹⁻⁷ The domains correspond to the two favorable sites, fcc and hcp. This behavior is expected to be ubiquitous and should not depend strongly on the interaction potentials or the overlayer-substrate mismatch.⁷⁻⁹

An interesting system, which has a large mismatch of -7.1% , is Cu on Pd(111). Experimentally it has been found that the growth of Cu is layer-by-layer at room temperature.¹⁰⁻¹² In the submonolayer regime the substrate becomes gradually covered by two-dimensional (2D) islands.¹⁰ Although near 1 ML coverage there is some indication of dislocations,^{10,12,13} only at 2-3 ML the average lattice constant reduces to the relaxed value. This has been interpreted as a transition to relaxed morphology^{11,12} leading to the conclusion that the pseudomorphic structure is stable up to 2-3 ML.

In this work we unravel the atomic level stress release mechanisms of Cu on the Pd(111) surface from the submonolayer up to one monolayer regimes under conditions when no alloying takes place.¹⁴ We employ two efficient computational methodologies, namely, basin-hopping global optimization and energy minimization with repulsive bias potential. Our numerical results are consistent with the experimentally observed layer-by-layer growth. However, we find that the structure of the Cu adsorbate is not fully pseudomorphic even at low coverages. Instead, the Cu overlayer forms fcc and hcp stacking domains, separated by partial misfit dislocations. We also estimate the minimum energy path and energy barriers for transitions from the ideal epitaxial state to the fcc-hcp domain pattern.

Model and methods. In our calculations the system is described as a stack of rectangular (111) layers whose shorter

edges are along close-packed rows in the x direction, longer edges are in the y direction and z axis is perpendicular to the (111) plane. Periodic boundary conditions are applied in the x and y directions and two bottom substrate layers are fixed to the bulk values. The number of atomic rows in the y direction is chosen to be twice that in the x direction. With this geometry the smallest simulation cell which can accommodate layers with ideal lattice spacing of both Cu and Pd has 15×30 edge Pd atoms.

Metal interactions are modeled by the embedded atom method (EAM),^{15,16} which has given a good agreement with experiments on the Cu/Pd(100) system.¹⁷ The energy of a Cu impurity in a Pd host is close to the experimental value¹⁶ and the surface energies are consistent with the measurements¹⁶ and first-principles studies.¹⁸ The potential correctly predicts the system to be in the wetting regime although for a bulk alloy it favors fcc instead of the observed B2 bcc phase.¹⁹ To identify the low-energy configurations, we employ two complementary strategies, namely, basin-hopping global optimization (GO) and activation-minimization (AM) techniques. Both methods have been described in detail elsewhere,²⁰⁻²² thus we will only recite their main features here.

Global optimization. Basin-hopping global optimization is a tool for finding, with fixed size and chemical composition, the atomic configuration with the lowest potential energy.²¹ The GO tool can start the search from any given configuration, and at each step it proceeds as follows: (i) the Cu atoms are perturbed by the *shake* move described in Ref. 20 and alloying is prevented. (ii) The perturbed system, including the Pd slab, is locally minimized. (iii) The energy of the new local minimum is compared to the previous one and the move is accepted according to the standard Metropolis criterion.

Global optimizations for Cu island sizes $N_{\text{Cu}} > 20$ start from an initial, randomly-arranged Cu island locally minimized on top of a 15×30 Pd slab with thickness varying between 3 and 6. The two bottom layers are kept frozen in their ideal bulk configuration, while the other layers are allowed to relax during the local minimization procedure. One



FIG. 1. (Color online) Left panel: low-energy structure from GO with $N_{\text{Cu}}=120$. Pd atoms are white, while Cu colors differ according to Cu stacking. Right panel: the map of atomic stress in the same island. Stress is quantified as in Refs. 27–29. The fcc and hcp areas are under tensile strain while the domain wall is nearly stress free.

run of 10^5 steps is performed for each of the systems considered.

Activation-minimization procedure. The AM technique starts from a perfectly pseudomorphic Cu overlayer. During both activation and energy minimization stages, the system follows the time-discretized Newtonian equations of motion which are solved with the standard leap-frog algorithm. We perform the energy minimizations with the molecular-dynamics cooling (MDC) technique.²³ On the activation stage we also apply MDC but now the system is under the influence of the repulsive bias potential (RBP).^{24,25} In some cases, before turning on the RBP, we increase the chance of getting certain kind of defects by perturbing some selected atoms slightly to a direction which is likely to initiate a nucleation process. After switching off the RBP we further relax the final state with MDC. During activation, we save intermediate states and use them as an input for the nudged elastic band (NEB) method to find the minimal energy path between the initial and final states.²⁶ Our final results were checked by varying the simulation box size, Pd slab thickness, perturbations and the level of biasing and our conclusions do not depend on these details either for AM or GO.

Submonolayer regime. In the submonolayer regime, we performed GO for several island sizes ($5 < N_{\text{Cu}} < 120$). Consistently with the experimentally observed layer-by-layer growth,^{10,11} all the global minimum energy structures for $N_{\text{Cu}} > 5$ are flat. A low-energy structure for $N=120$ is shown in Fig. 1. It is worth noticing that the adsorption energy of the island does not substantially depend on its stacking. When the Pd slab has stacking sequence ABC, the Cu atoms in the next layer can occupy sites A or B, which are referred to as fcc or hcp stackings, respectively.^{6,7} The potential correctly assigns a lower cohesion energy to fcc than to hcp bulk although the difference is small, $E_{\text{fcc-hcp}} < 2$ meV/atom. The best adsorption site for a single Cu atom on Pd(111) is on the fcc site, the energy difference from the hcp stacking being 4.4 meV. Consequently, islands with $N_{\text{Cu}} < 41$ are completely on the fcc sites. All the larger islands, where $60 \leq N_{\text{Cu}} \leq 120$, are in both fcc and hcp stackings.

A stress color-scale graph is shown in Fig. 1. The stress of atom i is quantified as the isostatic local atomic pressure,^{27–29} $p(i) = -\sum_j r_{ij}(\partial E / \partial r_{ij}) / 3$, where j runs over the neighbors of atom i , E is the total potential energy of the system, and r_{ij} is the distance between i and j . The tensile stress is largest near the center of the fcc and hcp domains and stress release originates from partial dislocations running along the domain walls.

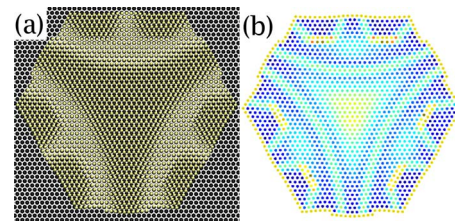


FIG. 2. (Color online) (a) shows a stacking domain trigon in a hexagonal Cu island (light color) and the next-nearest substrate layer (dark color). When the adsorbate occupies hcp sites, the dark substrate is occluded, otherwise the stacking is fcc-like and the substrate is visible through the overlayer. (b) shows the energy map for the trigon in (a). The lightly colored high-energy regions are in the same locations as the stacking domain walls of (a) and as the highly stressed region at the center of the trigon.

In similar systems exhibiting 2D incommensurate ordering, the walls are called heavy or superheavy, corresponding to atoms at neighbor fcc and hcp sites or atoms on bridge positions, respectively.³⁰ The latter are more common in islands. In our system both walls are often distorted to bring atoms closer to the equilibrium distance. Especially the superheavy walls are typically curved and extended over several lattice spacings. While the wall atoms are at disadvantageous positions, the elastic relaxation, which would not be possible without the domain structure, has longer range and releases energy in the whole island. Larger hexagonal islands also display the domains in a pattern which is called a trigon.⁷ The center of the trigon shows energy increase due to high stress levels, as shown in Fig. 2(b).

Monolayer regime. Although we find that pseudomorphic Cu at 1 ML coverage, which is shown in Fig. 3, panel A, is stable upon local energy minimization, both GO and AM methods can locate lower energy structures. They consist of

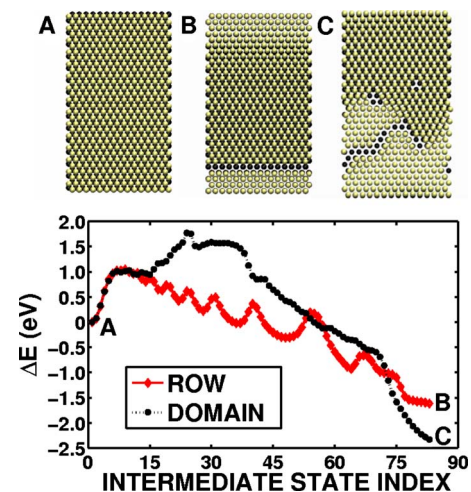


FIG. 3. (Color online) Top: panel A shows the 1 ML pseudo-morphic state, panels B and C are two fcc-hcp domain configurations obtained from the AM procedure. The panels A, B, and C show the 15×30 overlayer (light color) and the next-nearest substrate layer (dark color), as in Fig. 2. Bottom: minimum energy paths connecting the pseudo-morphic state to fcc-hcp domain configurations.

alternating fcc and hcp stacking domains similar to the submonolayer islands. We will refer to these structures collectively as the fcc-hcp domain configurations (cf. Fig. 2). We are thus led to investigate what is the stability of the pseudomorphous film relative to the fcc-hcp domains and to what extent the adsorbate is epitaxial.

To mimic the row dislocation networks sometimes reported from similar systems,³¹ we perturb the 15×30 simulation cell by pushing a x directional row of the Cu layer 0.05 \AA down to the negative z direction. We activate the system with only 3 layers of Pd, but after finding a transition path, we increase the substrate thickness to 9 by adding six layers below the originals. As before, the two bottom of the enlarged system are kept frozen. The AM then yields a configuration where the overlayer has contracted and split to reveal an x directional row from the substrate, see Fig. 3, panel B. This row dislocation state has lower energy than the pseudomorphous state and contains fcc-hcp domains, but the energy barrier exceeds 1 eV.

The fcc-hcp domains both in the submonolayer islands and from the GO runs at 1 ML seem to have a fairly irregular structure. To estimate the energy barrier connecting the pseudomorphous layer to these structures, we pushed 15 randomly selected Cu atoms 0.05 \AA to the nearest y edge direction. The result after the AM procedure also shows fcc-hcp domains, see Fig. 3, panel C. These domains have striking similarity to what is described in Refs. 1–7. The energy path connecting the pseudomorphous state to the fcc-hcp domain is characterized by multiple large barriers which exceed the row dislocation barrier. The holes on the overlayer are now better aligned to allow stress release in several directions (cf. Fig. 2, panels B and C). Because the row dislocation shows the stacking domains and the energy barrier is in the same range as in the disordered case, it is possible to view it as a special case which also belongs to the fcc-hcp domain class.

The NEB energy paths of Fig. 3 suggest that if a uniform pseudomorphous overlayer can be formed, high-energy barriers will prevent the decay into the fcc-hcp domain structure. If this overlayer was grown with conventional deposition methods, some adatoms would eventually land on the film. Therefore we are led to ask if a few adatoms on a single pseudomorphous layer would be enough to activate a defect nucleation.

In our initial state we placed N_{ad} Cu adatoms, all at the same time, on top of a pseudomorphous layer at randomly selected fcc stacking positions. Substrate layer sizes 15×30 , 30×60 , and 40×80 were used with increasing N_{ad} . We find that with simple energy minimization N_{inc} spontaneously incorporate into the interfacial layer. For all the cases considered N_{inc} saturates near the number difference between the fully pseudomorphous and fully relaxed layers, which is roughly $2f$ times the layer size. The remaining Cu adatoms stay in the topmost layer. As a result of the incorporation, a fcc-hcp domain structure is again formed, as shown in Fig. 4. In saturation, the fcc stacking is slightly more frequent than hcp. GO runs also display similar low-energy patterns. Overlayer structures with fcc-hcp domains similar to those in Fig. 2 have been observed on various heteroepitaxial systems on (111) surfaces.⁷

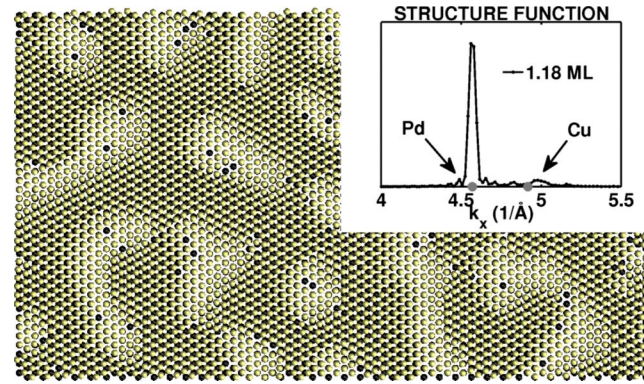


FIG. 4. (Color online) Randomly placed 0.18 ML adatoms on top of a pseudomorphous Cu layer incorporate spontaneously and nucleate a fcc-hcp stacking domain structure to the interfacial layer. The colors are as in Fig. 2. The sparse black spots are holes in the interfacial layer. Insert: the average structure function in the x direction for eight realizations of the adsorbate layer after random incorporation, all with the same nominal coverage 1.18 ML. The Pd-like peak, which is ideally above the left gray spot, is strong because the interior of both fcc and hcp domains has Pd-like lattice constant. The peaks near the ideal Cu-position (right gray spot) are related to the domain walls, where most of the stress relaxation takes place.

Discussion. The results presented here are in agreement with the experimentally reported layer-by-layer growth of Cu on Pd(111) (Refs. 10–12) since flat islands are the low-energy configurations in the whole submonolayer range considered here. However, our results predict that the most favorable arrangement of Cu on top of Pd(111) is the fcc-hcp domain configuration rather than an epitaxial configuration. This result was obtained both from the global optimization method as well as from the activated and spontaneous relaxation starting from a perfect epitaxial state.

The experimental peak intensities from Auger electron spectroscopy (AEG), low-energy electron spectroscopy (LEED),¹² and reflection high-energy electron diffraction (RHEED) (Ref. 11) were interpreted to indicate that the Cu deposition is epitaxial up to 2–3 ML. In contrast, in our calculations fcc-hcp domain configurations occur already at the submonolayer regime. In the measured RHEED intensities, however, there is a Cu-like peak already visible and distinguishable from the Pd-like at $\approx 1.5 \text{ ML}$.¹¹ To estimate the degree of epitaxy in the overlayers exhibiting fcc-hcp domains, we plot the average structure function $|\sum_{\text{Cu}} \exp(ik_x x)|^2$ averaged over eight configurations after incorporation at 1.18 ML coverage in Fig. 4. The averaging is done to remove the dependence on the random adatom positions. Most of the signal is Pd-like because both the fcc and hcp domains are nearly coherent with the substrate. However, there is some relaxation originating from the domain walls and this produces two peaks near the ideal Cu-like location, corresponding to distorted heavy and superheavy walls. After averaging the Cu peaks are less visible and for realistic temperatures the fluctuations would further smear the data. If the Pd signal slope were changing faster than the slope of the Cu signal as a function of the wave vector length k_x , the latter signal would be difficult to resolve. However,

there is no reason why the morphology could not change to completely relaxed layers from the domain structure after deposition of a few layers as the experimental data shows. Thus, in our view, the existence of the stacking domains is not ruled out by the experiments.

Similar fcc-hcp domains have been observed experimentally in Cu/Ru(0001) with misfit -5.5% .¹⁻⁵ Theoretical studies suggest that the existence of the structure is not sensitive to details of the stressed fcc(111) system.^{6,7} Instead, these structures arise from the existence of two favorable states, fcc and hcp sites, and from the competition between strain energy relief and the energy cost for dislocation formation. The loss of epitaxy of Cu/Ru(0001) occurs above 1 ML coverage but in our system with misfit -7% the critical coverage is below 1 ML, which is in line with the higher stress level. In the Cu/Pd(111) system the incorporation would not lead to further stress release because the layer is already patterned below 1 ML. However, in the Cu/Ru(0001) system the process is visible. The x-ray photoemission spectroscopy (XPS) intensity data for Cu/Pd(111) system also leave room for layer-by-layer morphology above 1 ML.¹¹

Conclusion. We have used computational approach to understand the structure of Cu films on the Pd(111) surface in the low coverage regime extending from 20-atom islands to 1 ML. Our results agree with layer-by-layer growth as is observed experimentally. Our model predicts that the epitaxiality is lost already below 1 ML coverage and Cu forms hcp and fcc stacking domains, separated by wall regions in which Cu recovers its lattice spacing and releases its tensile stress. This pattern, similar to what is seen in Cu/Ru(0001) at higher coverages, encourages further experimental investigations directly probing the overlayer structure.

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